503397964 07/17/2015

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3444589

SUBMISSION TYPE:		NEW ASSIGNMENT				
NATURE OF CONVEYANCE:		RELEASE OF SECURITY INTEREST				
CONVEYING PARTY	/ DATA					
		Name	Execution Date			
BRIGHTWOOD LOAN SERVICES LLC		LLC, AS COLLATERAL AGENT	07/17/2015			
RECEIVING PARTY	DATA					
Name:		ILC HOLDINGS, INC.				
Street Address:	105 WILB	105 WILBUR PLACE				
City:	BOHEMIA	BOHEMIA				
State/Country:	NEW YOF	NEW YORK				
Postal Code:	11716	11716				
Name:	ILC INDU	ILC INDUSTRIES, LLC				
Street Address:	105 WILB	105 WILBUR PLACE				
City:	BOHEMIA	BOHEMIA				
State/Country:	NEW YOF	NEW YORK				
Postal Code:	11716	11716				
Name:	DATA DE	DATA DEVICE CORPORATION				
Street Address:	105 WILB	105 WILBUR PLACE				
City:	BOHEMIA	BOHEMIA				
State/Country:	NEW YOF	NEW YORK				
Postal Code:	11716	11716				
Name:	BETA TR	BETA TRANSFORMER TECHNOLOGY CORPORATION				
Street Address:	40 ORVIL	40 ORVILLE DRIVE				
City:	BOHEMIA	BOHEMIA				
State/Country:	NEW YOF	NEW YORK				
Postal Code:	11716	11716				

PROPERTY NUMBERS Total: 7

Property Type	Number	
Patent Number:	6388264	
Patent Number:	6613605	
Patent Number:	7132356	
Patent Number:	7421353	
Patent Number:	7271028	

Property Type	Number		
Patent Number:	7724848		
Patent Number:	8223905		
CORRESPONDENCE DATA			
Fax Number:	(312)863-7867		
	t to the e-mail address first; if that is un ded; if that is unsuccessful, it will be ser		
Phone:	3128637267		
Email:	jaclyn.digrande@goldbergkohn.com		
Correspondent Name:	JACLYN DI GRANDE - PARALEGAL		
Address Line 1:	GOLDBERG KOHN LTD.		
Address Line 2:	55 E MONROE ST., SUITE 3300		
Address Line 4:	CHICAGO, ILLINOIS 60603		
ATTORNEY DOCKET NUMB	R: 6483.082		
NAME OF SUBMITTER:	JACLYN DI GRANDE		
SIGNATURE:	/jaclyn di grande/		
DATE SIGNED:	07/17/2015		
Fotal Attachments: 3	·		
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RELEASE OF SECURITY INTEREST IN PATENTS

THIS RELEASE OF SECURITY INTEREST IN PATENTS ("Release") is made as of this 17th day of July 2015, by BRIGHTWOOD LOAN SERVICES LLC, in its capacity as collateral agent ("Collateral Agent"), in favor of ILC HOLDINGS, INC., a Delaware corporation, ILC INDUSTRIES, LLC, a Delaware limited liability company, DATA DEVICE CORPORATION, a Delaware corporation, and BETA TRANSFORMER TECHNOLOGY CORPORATION, a New York corporation (collectively, the "Companies").

FOR GOOD AND VALUABLE CONSIDERATION, the receipt and adequacy of which are hereby acknowledged, Collateral Agent hereby unconditionally and expressly releases, terminates, and extinguishes its liens and security interests it may have upon the patents listed on <u>Schedule I</u> attached hereto and made a part hereof, which liens and security interests were established under and pursuant to that certain Second Lien Intellectual Property Security Agreement dated July 15, 2014 executed by Companies in favor of Collateral Agent and recorded with the United States Patent and Trademark Office on July 16, 2014 at reel/frame 033347/0041.

Collateral Agent consents and agrees to execute and deliver, at the request and cost of Companies, such further instruments, documents and release forms as Companies may reasonably request to more effectively, release, terminate and extinguish any such liens and security interests upon such patents.

[Signature Page Follows]

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IN WITNESS HEREOF, Collateral Agent has caused this Release to be duly

executed by its duly authorized officer as of the day and year first above written.

BRIGHTWOOD LOAN SERVICES LLC, as Collateral Agent

By: Name: Damien Dwin

Title: Authorized Person

By: Name: Sengal Selassie

Title: Authorized Person

Patent Release

SCHEDULE I

PATENTS

Title	Patent No.	Issue Date
OPTOCOUPLER PACKAGE	6388264	5/14/02
BEING HERMETICALLY		
SEALED		
INTERCONNECTION	6613605	9/2/03
METHOD ENTAILING		
PROTUBERANCES FORMED		
BY MELTING METAL OVER		
CONTACT AREAS		
INTERCONNECTION	7132356	11/7/06
METHOD		
DIGITAL INTEGRATION	7421353	9/2/08
METHOD		
HIGH DENSITY ELECTRONIC	7271028	9/18/07
INTERCONNECTION		
PREDICTIVE SIGNAL	7724848	5/25/10
CANCELLATION FOR		
EXTRACTING 1 MB/S MIL-		
STD-1553 COMPONENT		
FROM COMPOSITE HIGH		
PERFORMANCE 1553 SIGNAL		
PREDICTIVE SIGNAL	8223905	7/17/12
CANCELLATION FOR		
EXTRACTING 1 MB/S MIL-		
STD-1553 COMPONENT		
FROM COMPOSITE HIGH		
PERFORMANCE 1553 SIGNAL		

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